

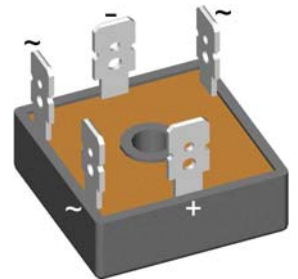
Standard Rectifier Module


3~ Rectifier	
V_{RRM}	= 1200 V
I_{DAV}	= 20 A
I_{FSM}	= 380 A

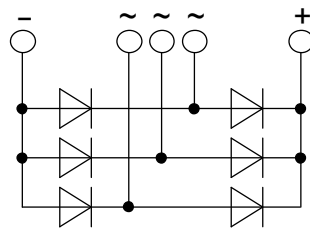
3~ Rectifier Bridge

Part number

VUO25-12NO8



 E72873



Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very low forward voltage drop
- Improved thermal behaviour

Applications:

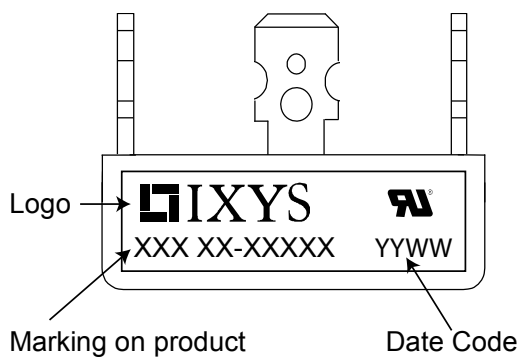
- Diode for main rectification
- For three phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

Package: FO-B

- Industry standard outline
- RoHS compliant
- ¼" fast-on terminals
- Easy to mount with one screw

Rectifier				Ratings				
Symbol	Definition	Conditions		min.	typ.	max.	Unit	
V_{RSM}	max. non-repetitive reverse blocking voltage					1300	V	
V_{RRM}	max. repetitive reverse blocking voltage					1200	V	
I_R	reverse current	$V_R = 1200$ V	$T_{VJ} = 25^\circ\text{C}$			40	μA	
		$V_R = 1200$ V	$T_{VJ} = 150^\circ\text{C}$			1.5	mA	
V_F	forward voltage drop	$I_F = 10$ A	$T_{VJ} = 25^\circ\text{C}$			1.05	V	
		$I_F = 30$ A				1.25	V	
		$I_F = 10$ A	$T_{VJ} = 125^\circ\text{C}$			0.94	V	
		$I_F = 30$ A				1.21	V	
I_{DAV}	bridge output current	$T_C = 85^\circ\text{C}$ rectangular	$T_{VJ} = 150^\circ\text{C}$ $d = \frac{1}{3}$			20	A	
V_{FO}	threshold voltage	} for power loss calculation only				0.77	V	
r_F	slope resistance					14.2	m Ω	
R_{thJC}	thermal resistance junction to case					8	K/W	
R_{thCH}	thermal resistance case to heatsink			1			K/W	
P_{tot}	total power dissipation			$T_C = 25^\circ\text{C}$			15	W
I_{FSM}	max. forward surge current	$t = 10$ ms; (50 Hz), sine	$T_{VJ} = 45^\circ\text{C}$			380	A	
		$t = 8,3$ ms; (60 Hz), sine	$V_R = 0$ V			410	A	
		$t = 10$ ms; (50 Hz), sine	$T_{VJ} = 150^\circ\text{C}$			325	A	
		$t = 8,3$ ms; (60 Hz), sine	$V_R = 0$ V			350	A	
I^2t	value for fusing	$t = 10$ ms; (50 Hz), sine	$T_{VJ} = 45^\circ\text{C}$			720	A ² s	
		$t = 8,3$ ms; (60 Hz), sine	$V_R = 0$ V			700	A ² s	
		$t = 10$ ms; (50 Hz), sine	$T_{VJ} = 150^\circ\text{C}$			530	A ² s	
		$t = 8,3$ ms; (60 Hz), sine	$V_R = 0$ V			510	A ² s	
C_J	junction capacitance	$V_R = 400$ V; $f = 1$ MHz	$T_{VJ} = 25^\circ\text{C}$		10		pF	

Package FO-B		Ratings				
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			100	A
T_{stg}	storage temperature		-40		125	°C
T_{VJ}	virtual junction temperature		-40		150	°C
Weight				20		g
M_D	mounting torque		1.8		2.2	Nm
$d_{Spp/App}$	creepage distance on surface striking distance through air	terminal to terminal	9.0	7.0		mm
$d_{Spb/Apb}$		terminal to backside	10.0	10.0		mm
V_{ISOL}	isolation voltage	t = 1 second			3000	V
		t = 1 minute	50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA		2500	V

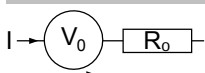


Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	VUO25-12NO8	VUO25-12NO8	Box	50	465100

Equivalent Circuits for Simulation

* on die level

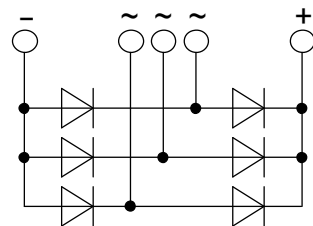
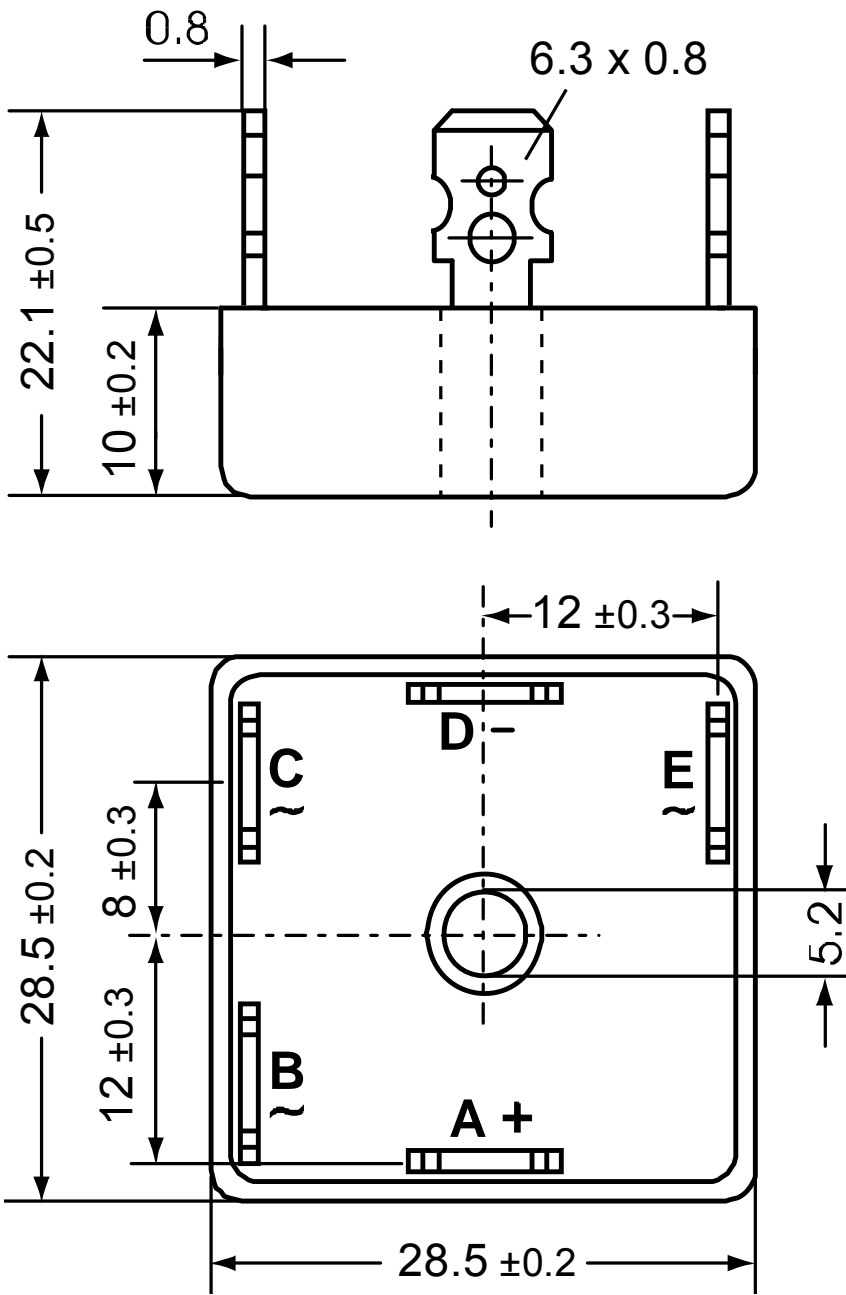
$T_{VJ} = 150^\circ\text{C}$



Rectifier

$V_{0\max}$	threshold voltage	0.77	V
$R_{0\max}$	slope resistance *	13	mΩ

Outlines FO-B



Rectifier

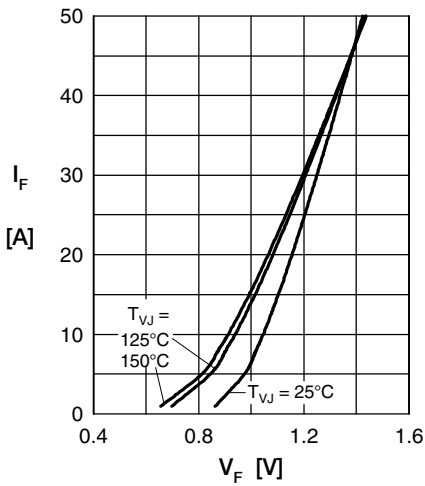


Fig. 1 Forward current vs. voltage drop per diode

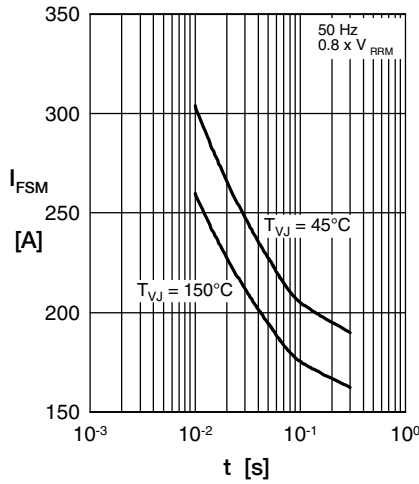


Fig. 2 Surge overload current vs. time per diode

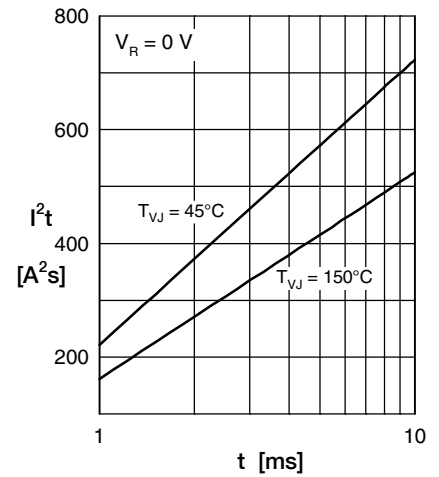


Fig. 3 I^2t vs. time per diode

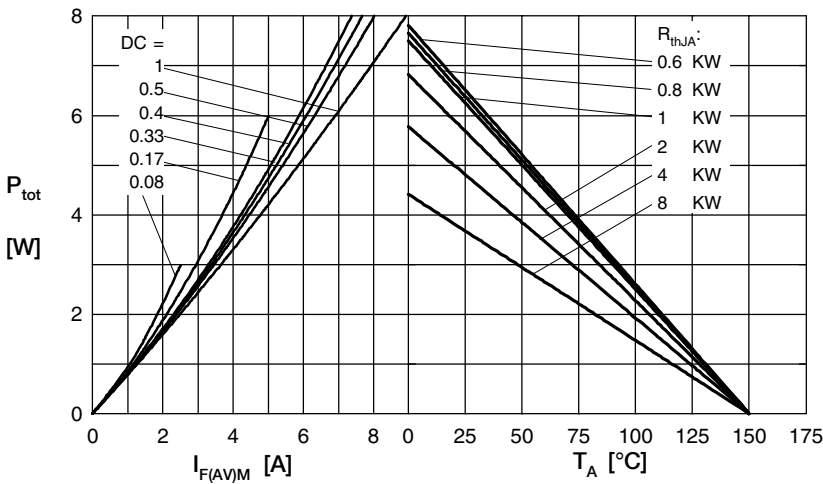


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

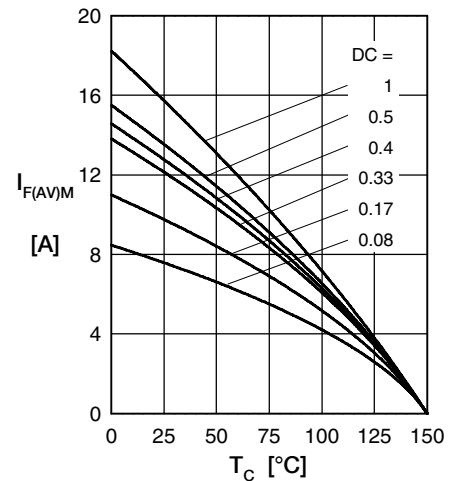


Fig. 5 Max. forward current vs. case temperature per diode

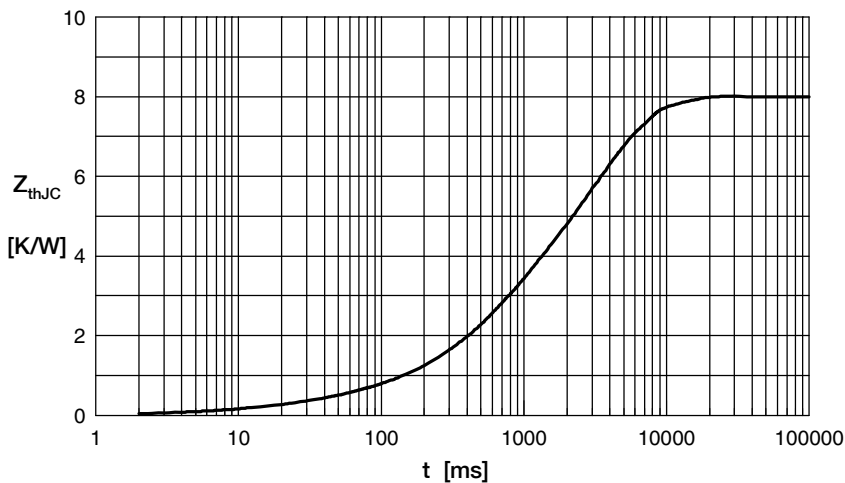


Fig. 6 Transient thermal impedance junction to case vs. time per diode

Constants for Z_{thJC} calculation:

i	R_{th} (K/W)	t_i (s)
1	0.040	0.005
2	0.250	0.030
3	1.810	0.500
4	5.900	3.200